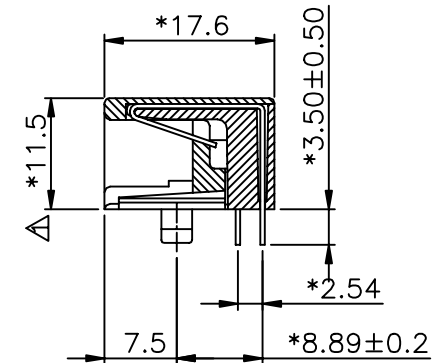


PC Board Layout Component Side Shown				
PORTS	DIM "A" ± 0.10 -0.30	DIM "B" ± 0.20	DIM "C" ± 0.15	DIM "D" ± 0.15
2	30.48	13.97	25.40	25.40
6	86.36	86.36	81.28	81.28
8	114.30	97.79	109.22	109.22

1. STORAGE : -40°C TO +85°C.
2. OPERATION : -40°C TO +85°C.
3. WAVE SOLDER TEMPERATURE: 230°C TO 250°C 5~10 SECONDS.
4. RoHS COMPLIANT.
MATES WITH MODULAR PLUG CONFORMING TO
FCC PART 68, SUBPART F.
CUL FILE NO. E163191

△ 3 A-2PORTS
E-6PORTS
G-8PORTS

DETACHED LISTS			DFTO SHINE		DATE 3/31/'01		 FULL RISE ELECTRONIC CO., LTD			
	TOLERANCES EXCEPT AS NOTED		CHKD ASHELLY		DATE 2006/9/8					
	MM .0 ± 0.2 .00 ± 0.15 .000 ± 0.075 ± ± ±		MFO		DATE		TITLE 11.5 SIDE ENTRY PCB GANG JACK 10P			
			APPVL LUSHENG		DATE 2006/9/8					
			MATERIAL :							
	ANGLES ± 0.5		QT'Y :		DRAWING NO. GE563062-LC				SIZE	REV
		FINISH :		/PART NO. SEE NOTE				A3	4	
		SCALE : 4:5		DO NOT SCALE DRAWING				SHEET 1	OF 1	
THIRD ANGLE PROJECTION										